

Engineering Development Model

Low Pass Filter

SXLP-EDU0934

Surface Mount

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.

Please click "Back", and then click "Contact Us" for Applications support.



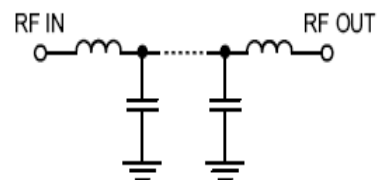
CASE STYLE : HF1139

ELECTRICAL SPECIFICATIONS 50Ω @ +25°C

Parameter	Min.	Typ.	Max.	Units
Passband (Loss < 1 dB)	DC		29	MHz
Insertion loss 3dB		32.5		MHz
Stopband (Loss > 20 dB)	38		41	MHz
(Loss > 40 dB)	41		525	MHz
Passband VSWR		1.2		(:1)
Stopband VSWR		20		(:1)

Functional Schematic

MAXIMUM RATINGS	
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power Input	0.5 W



PIN CONNECTIONS

Input	1
Output	8
Not Connected	-
Case Ground	2,3,4,5,6,7



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS



REV. X1
SXLP-EDU0934
URJ
080405
Page 1 of 1

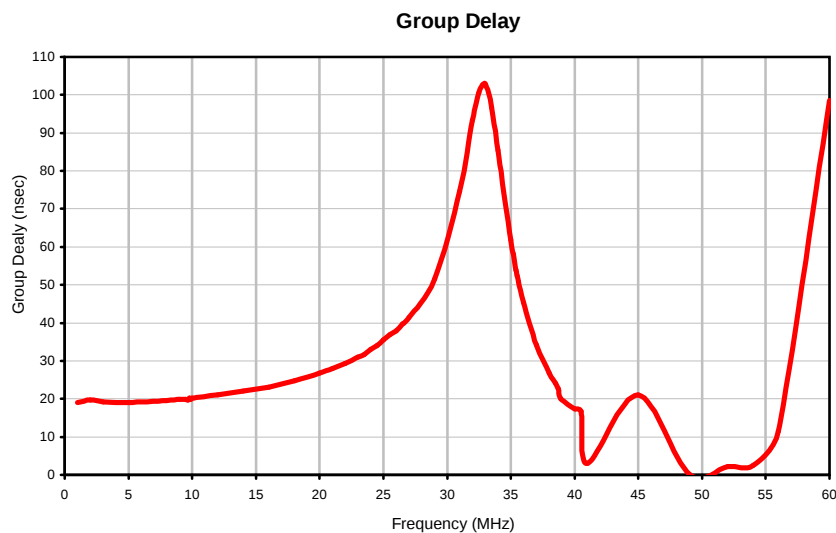
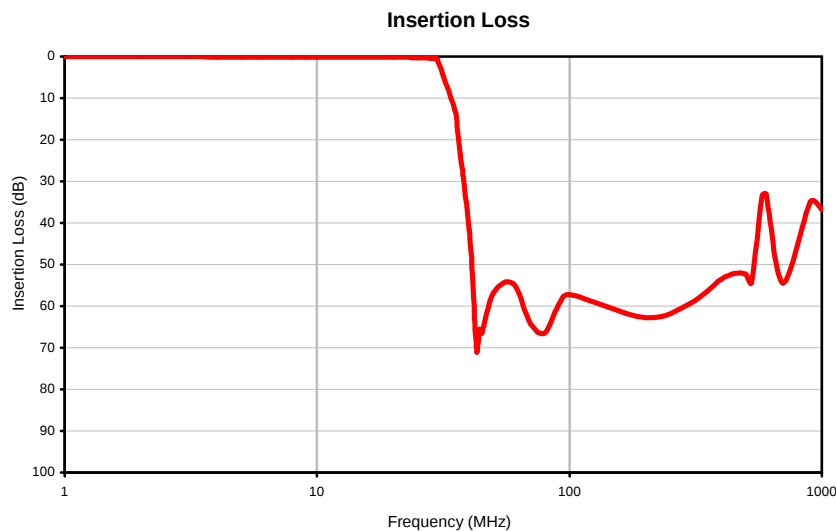
Surface Mount Low Pass Filter

SXLP-EDU0934

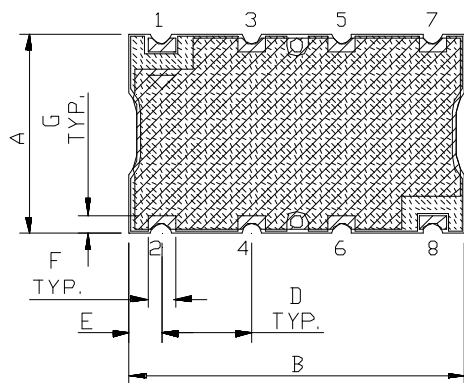
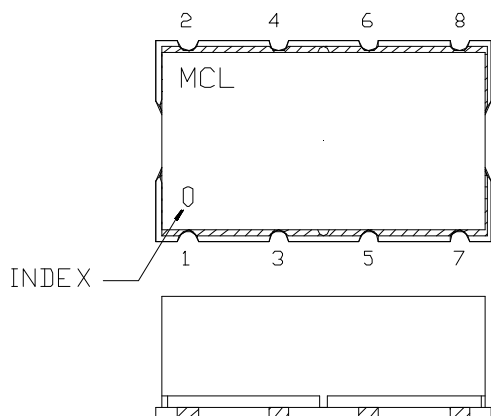
Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)	FREQUENCY (MHz)	GROUP DELAY (nsec)
1.0	0.04	33.14	1.0	19.10
2.0	0.05	27.28	2.0	19.68
3.0	0.07	23.91	3.0	19.25
4.0	0.09	21.63	4.0	19.12
5.0	0.10	20.01	5.0	19.10
6.0	0.13	18.82	8.0	19.50
8.0	0.16	17.37	9.0	19.92
9.0	0.18	17.01	9.5	19.96
10.0	0.18	16.87	9.7	19.71
20.0	0.23	21.22	9.8	20.14
25.0	0.34	19.11	9.9	19.86
29.0	0.50	20.41	10.0	20.29
30.0	0.58	21.06	12.0	20.97
35.0	12.54	0.94	14.0	22.15
36.0	17.98	0.55	16.0	23.14
37.0	23.52	0.39	18.0	24.84
38.0	29.17	0.30	20.0	26.82
40.0	41.63	0.22	21.0	28.04
41.0	49.43	0.19	22.0	29.34
42.0	61.27	0.17	23.0	30.95
43.0	71.15	0.17	23.5	31.64
44.0	65.55	0.16	24.0	33.08
45.0	66.50	0.15	24.5	34.00
50.0	56.84	0.12	25.0	35.53
60.0	54.57	0.10	25.5	36.90
70.0	64.31	0.13	26.0	37.93
80.0	66.48	0.11	26.5	39.76
90.0	59.77	0.12	27.0	41.37
100.0	57.17	0.13	29.0	51.48
200.0	62.79	0.19	31.0	74.65
300.0	59.39	0.23	32.0	93.34
400.0	53.54	0.26	32.5	100.56
450.0	52.19	0.26	33.0	102.96
500.0	52.25	0.28	33.5	96.74
525.0	54.26	0.28	34.0	85.45
580.0	33.45	0.34	35.0	61.85
600.0	33.02	0.32	35.2	58.16
700.0	54.51	0.35	35.4	53.83
900.0	34.98	0.42	35.5	52.38
1000.0	36.78	0.26	35.6	50.83
1100.0	36.73	0.25	36.0	45.24
1200.0	36.16	0.27	37.0	34.26
1300.0	35.44	0.32	38.0	26.78
1400.0	34.73	0.35	38.5	24.12
1500.0	33.90	0.44	38.7	22.69
1600.0	33.24	0.59	38.9	20.12
1800.0	32.06	0.59	40.0	17.37
2000.0	31.42	0.62	40.5	16.75
2200.0	32.25	0.74	41.0	2.95
2400.0	32.22	0.85	45.0	21.06
2500.0	31.61	1.00	49.0	0.23
2600.0	31.14	1.19	52.0	2.22
2800.0	29.22	1.33	54.0	2.45
3000.0	27.42	1.50	56.0	11.44
3200.0	23.43	2.31	60.0	98.49

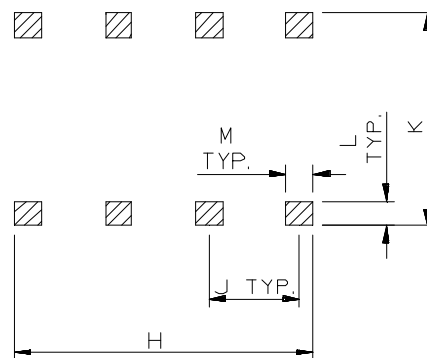
Typical Performance Curves



Outline Dimensions



PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	L	M	WT. GRAMS
HF1139	.44 (11.18)	.74 (18.80)	.27 (6.86)	.200 (5.08)	.07 (1.78)	.060 (1.52)	.040 (1.02)	.660 (16.76)	.200 (5.08)	.470 (11.94)	.055 (1.40)	.060 (1.52)	3.0

Dimensions are in inches (mm). Tolerances: 2 Pl. ± 0.015 "; 3 Pl. ± 0.01 "

Notes:

- Case material: Nickel-Silver alloy.
- Base: Printed wiring laminate.
- Termination finish:
 - For RoHS Case Styles: 2-5 μ inch (.05-.13 microns) Gold over 120-240 μ inch (3.05-6.10 microns) Nickel plate.
 - For RoHS-5 Case Styles: Tin-Lead plate.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS



Tape & Reel Packaging TR-F5



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
32	16	13	500

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010

Mini-Circuits ISO 9001 & ISO 14001 Certified

INTERNET <http://www.minicircuits.com>

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-65° to 150° C Ambient Environment	Individual Model Data Sheet
Autoclave	15 psig, 100% RH, 121°C, 96 hours	JESD22-A102-C, Condition C
Temperature Cycling	-65° to 150°C, 100 cycles	JESD22-A104
Temperature Humidity	85°C/ 85% RH, 168 hours	JESD22-113
Solder Reflow Heat	Sn-Pb Eutetic Process: 240°C peak Pb-Free Process: 260°C peak	J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1
Moisture Sensitivity: Level 1	Bake at 125°C for 24 hours Soak at 85°C/85% RH for 168 hours, Reflow 3 cycles at 240°C peak (Non-RoHS) or 260°C (RoHS)	J-STD-020
Solderability	10X magnification, 95% coverage	JESD22-B102, Method 1: Dip and Look Test
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D